# TPS76030, TPS76032, TPS76033, TPS76038, TPS76050 LOW-POWER 50-mA LOW-DROPOUT LINEAR REGULATORS

SLVS144D - JULY 1998 - REVISED MAY 2001

- 50-mA Low-Dropout Regulator
- Fixed Output Voltage Options: 5 V, 3.8 V, 3.3 V, 3.2 V, and 3 V
- Dropout Typically 120 mV at 50 mA
- Thermal Protection
- Less Than 1-μA Quiescent Current in Shutdown
- -40°C to 125°C Operating Junction Temperature Range
- 5-Pin SOT-23 Package
- ESD Protection Verified to 1.5 kV Human Body Model (HBM) per MIL-STD-883C

# DBV PACKAGE (TOP VIEW) EN GND IN 3 2 1 4 5 NC OUT

NC - No internal connection

## description

The TPS760xx is a 50 mA, low dropout (LDO) voltage regulator designed specifically for battery-powered applications. A proprietary BiCMOS fabrication process allows the TPS760xx to provide outstanding performance in all specifications critical to battery-powered operation.

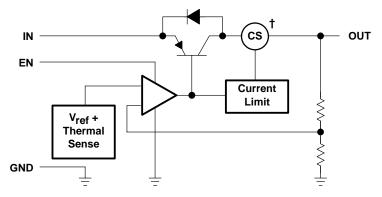
The TPS760xx is available in a space-saving SOT–23 package and operates over a junction temperature range of –40°C to 125°C.

#### **AVAILABLE OPTIONS**

TJ	VOLTAGE	PACKAGE	PART NUMBER	SYMBOL
	3 V		TPS76030DBVR	PAGI
	3.2 V		TPS76032DBVR	PAOI
-40°C to 125°C	3.3 V	SOT-23	TPS76033DBVR	PAHI
	3.8 V		TPS76038DBVR	PAJI
	5 V		TPS76050DBVR	PANI

NOTE: The DBV package is available taped and reeled only.

# functional block diagram



† Current sense



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



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#### **Terminal Functions**

TERMIN	TERMINAL I/O		DESCRIPTION					
NAME	NO.	1/0	DESCRIPTION					
EN	3	I	Enable input					
GND	2		Ground					
IN	1	I	Input voltage					
NC	4		No connection					
OUT	5	0	Regulated output voltage					

# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Input voltage range, V <sub>I</sub> <sup>‡</sup>	–0.3 V to 16 V
Voltage range at EN	
Peak output current	internally limited
Continuous total dissipation	See Dissipation Rating Table
Operating junction temperature range, T <sub>J</sub>	–40°C to 150°C
Storage temperature range, T <sub>stg</sub>	65°C to 150°C
ESD rating, HBM	1.5 kV

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### **DISSIPATION RATING TABLE**

BOARD	PACKAGE	$R_{ heta}$ JC	$R_{ heta JA}$	DERATING FACTOR ABOVE T <sub>A</sub> = 25°C	$T_A \le 25^{\circ}C$ POWER RATING	T <sub>A</sub> = 70°C POWER RATING	T <sub>A</sub> = 85°C POWER RATING	
Low K§	DBV	65.8 °C/W	259 °C/W	3.9 mW/°C	386 mW	212 mW	154 mW	
High K¶	DBV	65.8 °C/W	180 °C/W	5.6 mW/°C	555 mW	305 mW	222 mW	

<sup>§</sup> The JEDEC Low K (1s) board design used to derive this data was a 3 inch x 3 inch, two layer board with 2 ounce copper traces on top of the board. ¶ The JEDEC High K (2s2p) board design used to derive this data was a 3 inch x 3 inch, multilayer board with 1 ounce internal power and ground planes and 2 ounce copper traces on top and bottom of the board.

## recommended operating conditions

		MIN	NOM MAX	UNIT
	TPS76030	3.2	16	
	TPS76032	3.4	16	1
Input voltage, V <sub>I</sub>	TPS76033	3.5	16	٧
	TPS76038	4	16	1
	TPS76050	5.2	16	
Continuous output current, IC	)	0	50	mA
Operating junction temperatu	re, TJ	-40	125	°C

<sup>‡</sup> All voltages are with respect to device GND pin.

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# electrical characteristics over recommended operating free-air temperature range, $V_I = V_{O(nom)} + 1$ V, $I_O = 1$ mA, EN = $V_I$ , $C_O = 2.2$ $\mu F$ (unless otherwise noted)

	PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT		
			T <sub>J</sub> = 25°C	2.96	3	3.04			
		TPS76030	$T_J = 25^{\circ}C$ , 1 mA < $I_O$ < 50 mA	2.92		3.04	V		
			1 mA < I <sub>O</sub> < 50 mA	2.91		3.07			
			T <sub>J</sub> = 25°C	3.16	3.2	3.24			
		TPS76032	$T_J = 25^{\circ}C$ , 1 mA < $I_O$ < 50 mA	3.13		3.24	V		
			1 mA < I <sub>O</sub> < 50 mA	3.1 3.3					
			T <sub>J</sub> = 25°C	3.26	3.3	3.34			
Vo	Output voltage	TPS76033	$T_J = 25^{\circ}C$ , 1 mA < $I_O$ < 50 mA	3.23		3.34	V		
Ü			1 mA < I <sub>O</sub> < 50 mA	3.2		3.4	1		
			T <sub>J</sub> = 25°C	3.76	3.8	3.84			
		TPS76038	$T_J = 25^{\circ}C$ , 1 mA < $I_O$ < 50 mA	3.73	-	3.84	V		
			1 mA < I <sub>O</sub> < 50 mA	3.7		3.9			
			T <sub>J</sub> = 25°C	4.95	5	5.05			
		TPS76050	$T_J = 25^{\circ}C$ , 1 mA < $I_O$ < 50 mA	4.91		5.05	V		
			1 mA < I <sub>O</sub> < 50 mA	4.89		5.1			
I(standby)	Standby current	•	EN = 0 V			1	μΑ		
·(otalias)			$I_{O} = 0 \text{ mA},   T_{J} = 25^{\circ}\text{C}$		90	115	·		
			$I_O = 0 \text{ mA}$			130			
			$I_O = 1 \text{ mA},$ $T_J = 25^{\circ}\text{C}$		100	130			
			I <sub>O</sub> = 1 mA		-	170			
	Quiescent current (C	SND current)	$I_{O} = 10 \text{ mA},   T_{J} = 25^{\circ}\text{C}$		190	215	μΑ		
			I <sub>O</sub> = 10 mA		•	260			
			$I_{O} = 50 \text{ mA},   T_{J} = 25^{\circ}\text{C}$		850	1100			
			I <sub>O</sub> = 50 mA			1200			
		TPS76030	$4 \text{ V} < \text{V}_{\text{I}} < 16$ , $I_{\text{O}} = 1 \text{ mA}$		3	10			
		TPS76032	4.2 V < V <sub>I</sub> < 16, I <sub>O</sub> = 1 mA		3	10			
	Input regulation	TPS76033	4.3 V < V <sub>I</sub> < 16, I <sub>O</sub> = 1 mA		3	10	m∨		
	, ,	TPS76038	4.8 V < V <sub>I</sub> < 16, I <sub>O</sub> = 1 mA		3	10	1		
		TPS76050	$6 \text{ V} < \text{V}_1 < 16, \qquad I_0 = 1 \text{ mA}$		3	10			
Vn	Output noise voltage	) }	BW = 300 Hz to 50 kHz, $C_0 = 10 \mu F$ , $T_J = 25^{\circ}C$		190		μVrms		
	Ripple rejection		$f = 1 \text{ kHz},  C_O = 10 \mu\text{F},  T_J = 25^{\circ}\text{C}$		63		dB		
			I <sub>O</sub> = 0 mA T <sub>J</sub> = 25°C		1	3			
			I <sub>O</sub> = 0 mA		-	5			
			$I_O = 1 \text{ mA},$ $T_J = 25^{\circ}\text{C}$		7	10			
	_		I <sub>O</sub> = 1 mA		-	15	١		
	Dropout voltage		$I_{O} = 10 \text{ mA},   T_{J} = 25^{\circ}\text{C}$		40	60	mV		
			I <sub>O</sub> = 10 mA		-	90	1		
			$I_O = 50 \text{ mA}$ $T_J = 25^{\circ}\text{C}$		120	150	1		
			I <sub>O</sub> = 50 mA			180	1		
	Peak output current/	current limit		100	125	135	mA		
	High level enable in			2			V		
	Low level enable inp					0.8	V		
	·		EN = 0 V	-1	0	1	μΑ		
li li	Input current (EN)		EN = V <sub>I</sub>		2.5	5	μA		

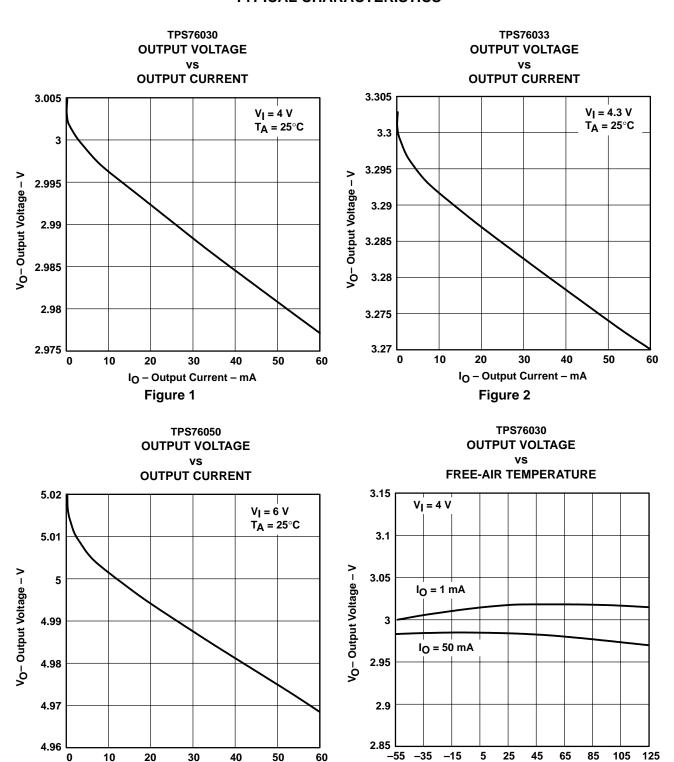


# **TPS76030, TPS76032, TPS76033, TPS76038, TPS76050 LOW-POWER 50-mA LOW-DROPOUT LINEAR REGULATORS**

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# **Table of Graphs**

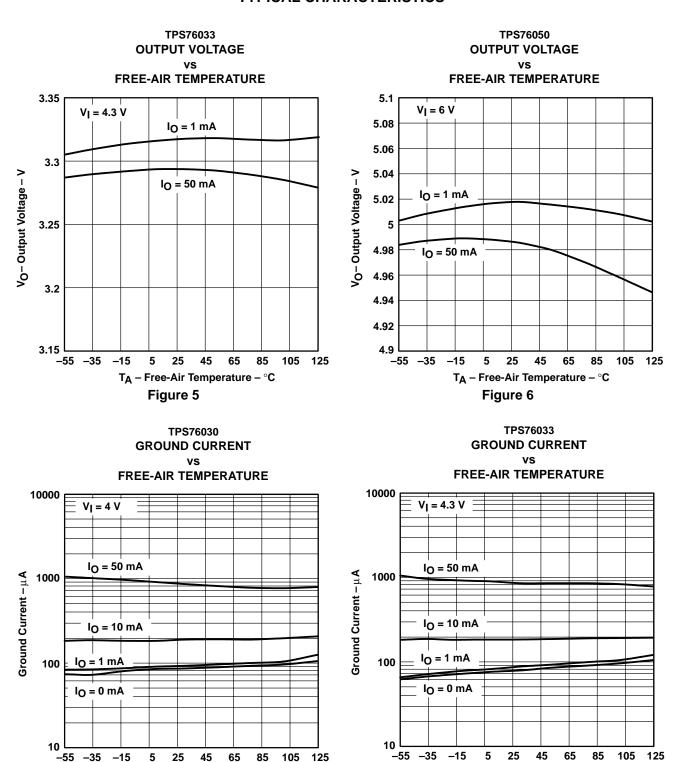
			FIGURE
V-	Output valtage	vs Output current	1, 2, 3
Vo	Output voltage	vs Free-air temperature	4, 5, 6
	Ground current	vs Free-air temperature	7, 8, 9
	Output noise	vs Frequency	10
Z <sub>o</sub>	Output impedance	vs Frequency	11
VDO	Dropout voltage	vs Free-air temperature	12
	Line transient response		13, 15
	Load transient response		14, 16





I<sub>O</sub> – Output Current – mA Figure 3 T<sub>A</sub> - Free-Air Temperature - °C

Figure 4



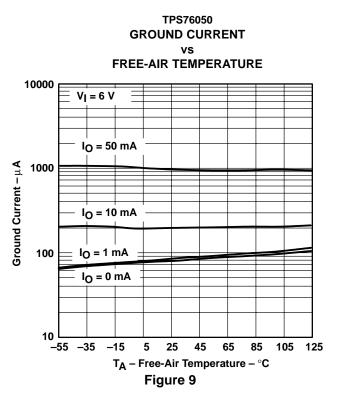


T<sub>A</sub> - Free-Air Temperature - °C

Figure 8

 $T_A$  – Free-Air Temperature –  $^{\circ}$ C

Figure 7



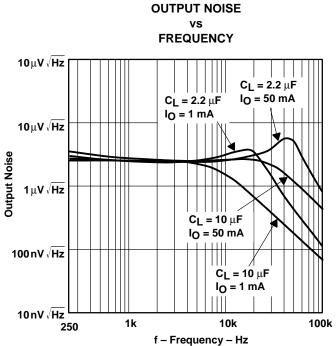
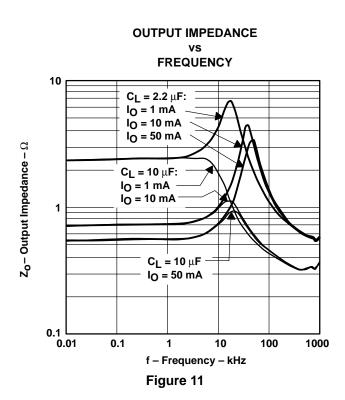
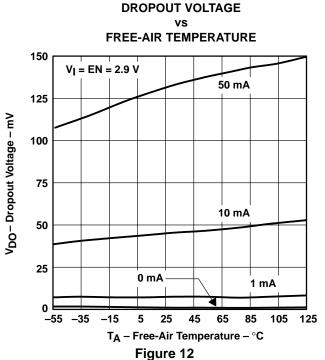


Figure 10

**TPS76030** 





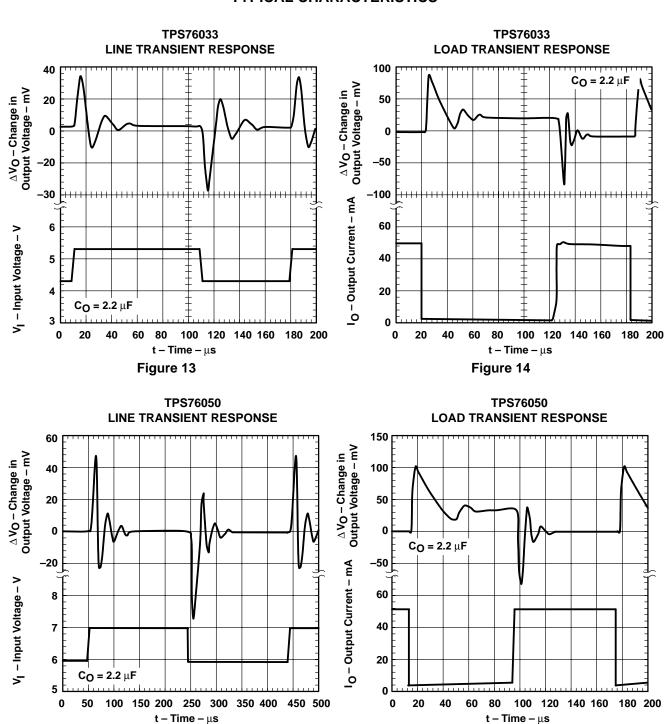




Figure 16

Figure 15

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#### APPLICATION INFORMATION

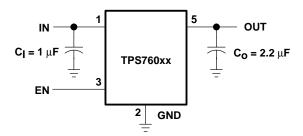


Figure 17. TPS760xx Typical Application

# over current protection

The over current protection circuit forces the TPS760xx into a constant current output mode when the load is excessive or the output is shorted to ground. Normal operation resumes when the fault condition is removed. An overload or short circuit may also activate the over temperature protection if the fault condition persists.

#### over temperature protection

The thermal protection system shuts the TPS760xx down when the junction temperature exceeds 160°C. The device recovers and operates normally when the temperature drops below 155°C.

## input capacitor

A 0.047  $\mu F$  or larger ceramic decoupling capacitor with short leads connected between IN and GND is recommended. The decoupling capacitor may be omitted if there is a 1  $\mu F$  or larger electrolytic capacitor connected between IN and GND and located reasonably close to the TPS760xx. However, the small ceramic device is desirable even when the larger capacitor is present, if there is a lot of high frequency noise present in the system.

#### output capacitor

Like all low dropout regulators, the TPS760xx requires an output capacitor connected between OUT and GND to stabilize the internal control loop. The minimum recommended capacitance value is 2.2  $\mu F$  and the ESR (equivalent series resistance) must be between 0.1  $\Omega$  and 20  $\Omega$ . Capacitor values of 2.5- $\mu F$  or larger are acceptable, provided the ESR is less than 20  $\Omega$ . Solid tantalum electrolytic, aluminum electrolytic, and multilayer ceramic capacitors are all suitable, provided they meet the requirements described above. Most of the commercially available 2.2- $\mu F$  surface-mount solid-tantalum capacitors, including devices from Sprague, Kemet, and Nichicon, meet the ESR requirements stated above. Multilayer ceramic capacitors should have minimum values of 2.5  $\mu F$  over the full operating temperature range of the equipment.

### enable (EN)

A logic zero on the enable input shuts the TPS760xx off and reduces the supply current to less than 1  $\mu$ A. Pulling the enable input high causes normal operation to resume. If the enable feature is not used, EN should be connected to IN to keep the regulator on all of the time. The EN input must not be left floating.

#### reverse current path

The power transistor used in the TPS760xx has an inherent diode connected between IN and OUT as shown in the functional block diagram. This diode conducts current from the OUT terminal to the IN terminal whenever IN is lower than OUT by a diode drop. This condition does not damage the TPS760xx, provided the current is limited to 100 mA.



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#### PACKAGING INFORMATION

Orderable part number	Status	Material type	Package   Pins	Package qty   Carrier	RoHS	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
						(4)	(5)		
TPS76030DBVR	Active	Production	SOT-23 (DBV)   5	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PAGI
TPS76030DBVR.A	Active	Production	SOT-23 (DBV)   5	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PAGI
TPS76030DBVT	Active	Production	SOT-23 (DBV)   5	250   SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PAGI
TPS76030DBVT.A	Active	Production	SOT-23 (DBV)   5	250   SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PAGI
TPS76032DBVR	Active	Production	SOT-23 (DBV)   5	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PAOI
TPS76032DBVR.A	Active	Production	SOT-23 (DBV)   5	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PAOI
TPS76033DBVR	Active	Production	SOT-23 (DBV)   5	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PAHI
TPS76033DBVR.A	Active	Production	SOT-23 (DBV)   5	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PAHI
TPS76033DBVT	Active	Production	SOT-23 (DBV)   5	250   SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PAHI
TPS76033DBVT.A	Active	Production	SOT-23 (DBV)   5	250   SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PAHI
TPS76038DBVR	Active	Production	SOT-23 (DBV)   5	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PAJI
TPS76038DBVR.A	Active	Production	SOT-23 (DBV)   5	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PAJI
TPS76038DBVT	Active	Production	SOT-23 (DBV)   5	250   SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PAJI
TPS76038DBVT.A	Active	Production	SOT-23 (DBV)   5	250   SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PAJI
TPS76050DBVR	Active	Production	SOT-23 (DBV)   5	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PANI
TPS76050DBVR.A	Active	Production	SOT-23 (DBV)   5	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PANI
TPS76050DBVRG4	Active	Production	SOT-23 (DBV)   5	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PANI
TPS76050DBVT	Active	Production	SOT-23 (DBV)   5	250   SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PANI
TPS76050DBVT.A	Active	Production	SOT-23 (DBV)   5	250   SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	PANI

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



# PACKAGE OPTION ADDENDUM

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(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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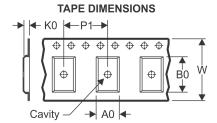
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# PACKAGE MATERIALS INFORMATION

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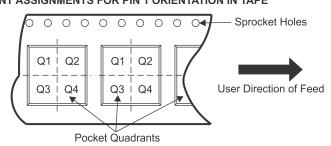
# TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS76030DBVR	SOT-23	DBV	5	3000	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TPS76030DBVT	SOT-23	DBV	5	250	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TPS76032DBVR	SOT-23	DBV	5	3000	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TPS76033DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS76033DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS76038DBVR	SOT-23	DBV	5	3000	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TPS76038DBVT	SOT-23	DBV	5	250	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TPS76050DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TPS76050DBVT	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3

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\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS76030DBVR	SOT-23	DBV	5	3000	182.0	182.0	20.0
TPS76030DBVT	SOT-23	DBV	5	250	182.0	182.0	20.0
TPS76032DBVR	SOT-23	DBV	5	3000	182.0	182.0	20.0
TPS76033DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS76033DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0
TPS76038DBVR	SOT-23	DBV	5	3000	182.0	182.0	20.0
TPS76038DBVT	SOT-23	DBV	5	250	182.0	182.0	20.0
TPS76050DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TPS76050DBVT	SOT-23	DBV	5	250	180.0	180.0	18.0



SMALL OUTLINE TRANSISTOR



#### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
  2. This drawing is subject to change without notice.
  3. Reference JEDEC MO-178.

- 4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.
- 5. Support pin may differ or may not be present.



SMALL OUTLINE TRANSISTOR



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE TRANSISTOR



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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